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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/621,445	07/18/2003	Yasuo Yamagishi	030868	1112
23850	7590	11/07/2005	EXAMINER	
ARMSTRONG, KRATZ, QUINTOS, HANSON & BROOKS, LLP 1725 K STREET, NW SUITE 1000 WASHINGTON, DC 20006				HOLLINGTON, JERMELE M
ART UNIT		PAPER NUMBER		
		2829		

DATE MAILED: 11/07/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary	Application No.	Applicant(s)	
	10/621,445	YAMAGISHI ET AL.	
	Examiner Jermele M. Hollington	Art Unit 2829	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) Responsive to communication(s) filed on 19 October 2005.
- 2a) This action is FINAL. 2b) This action is non-final.
- 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) Claim(s) 1-31 is/are pending in the application.
- 4a) Of the above claim(s) 3,5,8,9 and 12-31 is/are withdrawn from consideration.
- 5) Claim(s) 10 and 11 is/are allowed.
- 6) Claim(s) 1-2, 4 and 6-7 is/are rejected.
- 7) Claim(s) _____ is/are objected to.
- 8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) The specification is objected to by the Examiner.
- 10) The drawing(s) filed on _____ is/are: a) accepted or b) objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) All b) Some * c) None of:
 1. Certified copies of the priority documents have been received.
 2. Certified copies of the priority documents have been received in Application No. _____.
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- 1) Notice of References Cited (PTO-892)
- 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____
- 4) Interview Summary (PTO-413)
Paper No(s)/Mail Date _____
- 5) Notice of Informal Patent Application (PTO-152)
- 6) Other: _____

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

2. Claims 1-2 and 4 are rejected under 35 U.S.C. 102(e) as being anticipated by Eldridge et al (6727579).

Regarding claim 1, Eldridge et al disclose [see Fig. 33] a probe card (carrier assembly 3300) for testing a semiconductor chip (electronic component 3324) comprising: plurality of probes (resilient contact structure 3322); build-up interconnection layer (multi-layer substrate 3320) having a multilayer interconnection structure therein, said interconnection structure comprising plural interconnection layers [not number but shown] and one or more resin insulation layers (3320a) insulating said interconnection layers from each other, said build-up interconnection layer (3320) carrying said plurality of probes (3322) on a top surface thereof in electrical connection with said multilayer interconnection structure; and a decoupling capacitor (decoupling capacitor 3370) embedded resin insulation layer (3320a) constituting said build-up interconnection layer (3320) in electrical connection with one of said probes (3322) via said multilayer interconnection structure (3320), said multilayer interconnection structure (3320) including an inner via-contact (contact pads 3324) in the vicinity of said probe (3322).

Regarding claim 2, Eldridge et al disclose said capacitor (3370) has a thickness generally equal to or less than a thickness of said resin insulation layer (3320).

Regarding claim 4, Eldridge et al disclose said capacitor (3370) is formed in said build-up interconnection layer (3320) right underneath one of said probes (3322).

Claim Rejections - 35 USC § 103

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

4. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

5. Claims 6-7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Eldridge et al (6727579) in view of Fukuzumi et al (6548844).

Regarding claim 6, Eldridge et al disclose [see Fig. 33] a probe card (3300) for testing a semiconductor chip (3302), comprising: a capacitor (3370) embedded resin insulation layer (3320a) constituting said build-up interconnection layer (3320) in electrical connection with one of said probes (3322) via said multilayer interconnection structure (3320). However, they do not

disclose the feature of the capacitor as claimed. Fukuzumi et al disclose [Fig. 1] a capacitor structure 1 includes a dielectric film (capacitor dielectric film 3) of a complex oxide containing at least one metal element selected from the group consisting of Sr, Ba, Pb, Zr, Mg and Nb [see col. 5, lines 25-38]. Further, Fukuzumi et al teach that the addition of features of the capacitor is advantageous because it suppresses the deterioration of the data retaining characteristic that is originated from when annealing is performed in an atmosphere containing a reduce agent. It would have been obvious to a person having ordinary skill in the art at the time the invention was made to modify the apparatus of Horel et al by adding the features of the capacitor as taught by Fukuzumi et al in order to suppress the deterioration of the data retaining characteristic that is originated from when annealing is performed in an atmosphere containing a reduce agent.

Regarding claim 7, Eldridge et al disclose [see Fig. 33] a probe card (3300) for testing a semiconductor chip (3302), comprising: a capacitor (3370) embedded resin insulation layer (3320a) constituting said build-up interconnection layer (3320) in electrical connection with one of said probes (3322) via said multilayer interconnection structure (3320). However, they do not disclose the feature of the capacitor as claimed. Fukuzumi et al disclose [Fig. 1] a capacitor structure 1 includes an upper (common electrode 4) and lower (dispersion electrode 2) electrodes sandwiching a dielectric film (capacitor dielectric film 3), said upper (4) and lower (2) electrodes containing at least one metal element or a metal oxide selected from the group consisting of Pt, Au, Cu, Pb, Ru, a Ru oxide, Ir, an Ir oxide, and Cr [see col. 5, lines 43-45 and col. 6, lines 8-25]. Further, Fukuzumi et al teach that the addition of features of the capacitor is advantageous because it suppresses the deterioration of the data retaining characteristic that is originated from when annealing is performed in an atmosphere containing a reduce agent. It would have been

obvious to a person having ordinary skill in the art at the time the invention was made to modify the apparatus of Horel et al by adding the features of the capacitor as taught by Fukuzumi et al in order to suppress the deterioration of the data retaining characteristic that is originated from when annealing is performed in an atmosphere containing a reduce agent.

Conclusion

Election/Restrictions

6. This application contains claims 12-31 drawn to an invention nonelected without traverse in Paper No. 12/1/04. A complete reply to the final rejection must include cancellation of nonelected claims or other appropriate action (37 CFR 1.144) See MPEP § 821.01.
7. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Chraft et al (6911835) disclose different features of a capacitor for a semiconductor device.
8. Claims 10-11 are allowed over the prior art.
9. The following is a statement of reasons for the indication of allowable subject matter: regarding claim 10, the primary reason for the allowance of the claim is due to the specific limitation of a test method of a semiconductor device comprising the step of before contacting said probe card to said semiconductor chip, of setting an impedance between said probe and said capacitor to be substantially equal to an impedance of a semiconductor package including therein said semiconductor chip and a capacitor, for a part between said semiconductor chip and said capacitor. Since claim 11 depends from claim 10, it is also have allowable subject matter.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jermele M. Hollington whose telephone number is (571) 272-1960. The examiner can normally be reached on M-F (9:00-4:30 EST) First Friday Off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nestor Ramirez can be reached on (517) 272-2034. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Jermele M. Hollington
Jermele M. Hollington
Primary Examiner
Art Unit 2829

JMH
November 2, 2005